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DOCKET NO. P-3584

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants:

Sheldon Aronowitz, Helmut Puchner, Ravindra A. Kapre, and James P.

Kimball

Assignee:

LSI Logic Corporation

Title:

FORMATION OF INTEGRATED CIRCUIT STRUCTURE USING

ONE OR MORE SILICON LAYERS FOR IMPLANTATION AND

OUT-DIFFUSION IN FORMATION OF DEFECT-FREE

SOURCE/DRAIN REGIONS AND ALSO FOR SUBSEQUENT

FORMATION OF SILICON NITRIDE SPACERS

Serial No.:

Unknown

Filed:

Herewith

Group Art Unit: Unknown

Attorney Docket No. P-3584

Examiner: Unknown

May 11, 1998

RECORDATION FORM COVER SHEET PATENTS ONLY

To the Honorable Commissioner of Patents and Trademarks Washington, DC 20231

Sir:

Please record the attached original documents or copy thereof.

Name of conveying party(ies): 1.

> Sheldon Aronowitz Date of Execution: May 4, 1998

Date of Execution: May 5, 1998 Helmut Puchner

Date of Execution: May 5, 1998 Ravindra A. Kapre

Date of Execution: May 6, 1998 James P. Kimball

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PATENT

REEL: 9181 FRAME: 0536

	LSI Logic Corporation 1551 McCarthy Boulevard Milpitas, California 95035 U.S.A.			
3.	Nature of conveyance: Assignment			
4.	Application number(s) or patent number(s): If this document is being filed together with a new application, the execution date of the application is: May 4, 1998, May 5, 1998, May 5, 1998, and May 6, 1998.			
	A. Patent Application Serial Number: B. Patent Number:			
5.	Name and address of party to whom correspondence concerning document should be mailed:			
	John P. Taylor Post Office Box 1598 Temecula, California 92593-1598 U.S.A.			
6.	Total number of applications and patents involved: 1.			
7.	Total fee (37 CFR 3.41): <u>\$40.00.</u>			
8.	Attached is a check in the amount of \$40.00.			
	Charge Deposit Account No in the amount of \$ (A duplicate copy of this document is enclosed.)			
9.	Statement and Signature: To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document. F. Jaylor Reg. No. 22,369			
10.	Total number of pages including cover sheet, attachments and document:3			
•				

2.

Name and address of receiving party(ies):

Docket No.: P-3584 Patent

ASSIGNMENT

For good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, I/WE, the undersigned, Sheldon Aronowitz, Helmut Puchner, Ravindra A. Kapre, and James P. Kimball, do hereby sell, assign, and transfer to: LSI LOGIC CORPORATION, a corporation of Delaware, having a place of business at 1551 McCarthy Boulevard, Milpitas, California 95035, ("Assignee"), its successors, assigns, and legal representatives, the entire right, title and interest for the United States and all foreign countries, in and to any and all inventions and improvements which are disclosed in the application for United States Letters Patent,

(X)	which has been executed by the undersigned concurrently herewith,	
()	which was filed on19 and assigned Serial No	

and is entitled: "FORMATION OF INTEGRATED CIRCUIT STRUCTURE USING ONE OR MORE SILICON LAYERS FOR IMPLANTATION AND OUT-DIFFUSION IN FORMATION OF DEFECT-FREE SOURCE/DRAIN REGIONS AND ALSO FOR SUBSEQUENT FORMATION OF SILICON NITRIDE SPACERS" and in and to said application and all divisional, continuing, substitute, renewal, reissue, and all other applications for Letters Patent which have been or shall be filed in the United States and all foreign countries on any of said improvements; and in and to all original and reissued patents which have been or shall be issued in the United States and all foreign countries on said improvements; and in and to all rights of priority resulting from the filing of said United States application; and

Agree that said Assignee may apply for and receive Letters Patent for said improvements in its own name; and that, when requested, without charge to, but at the expense of, said Assignee, its successors, assigns and legal representatives, to carry out in good faith the intent and purpose of this Assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all said improvements; execute all rightful oaths, assignments, powers of attorney and other papers; communicate to said Assignee, its successors, assigns, and representatives, all facts known to the undersigned relating to said improvements and the history thereof; and generally do everything possible which said Assignee, its successors, assigns or representatives shall consider desirable for aiding in securing and maintaining proper patent protection for said improvements and for vesting title to said improvements and all applications to patents and all patents on said improvements, in said Assignee, its successors, assigns and legal representatives; and

Covenant with said Assignee, its successors, assigns and legal representatives that no assignment, grant mortgage, license, or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

Name:		Date:, 1998	Witness: 150 Land
	Sheldon Aronowitz		Witness: Letrica Rosentha
Name:_	Juli Ma	Date:	Witness: Latolake
	Helmut Puchner	,	Witness: Ufilia Robenthal Printed
Name:_	Kapea _	Date:, 1998	Witness:
	Ravindra A. Kapre	V	Witness: War Kosenha) Printed
Name:_	James Fintall	Date: 1/1a 6 , 1998	Witness: Jeuph VIII.
	James P. Kimball	•	Witness: VARIANT VESCLES Printed

Assignment Rec (4) RDED: 05/12/1998

PATENT REEL: 9181 FRAME: 0538